



Product Change Notification

Change Notification #: 117475 - 00

Change Title: **Passive/Active Combination Heat-Sink with Removable Fan BXSTS200C, MM# 915970
Passive Narrow Thermal Solution BXSTS200PNRW, MM# 915971
Passive Thermal Solution BXSTS200P, MM# 915972,
PCN 117475-00, Product Discontinuance, End of Life**

Date of Publication: June 1, 2020

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Last Product Discontinuance Order Date:	July 6, 2020
Last Product Discontinuance Shipment Date:	October 6, 2020

Description of Change to the Customer:

Intel is announcing the discontinuance of the Intel® Thermal Solutions BXSTS200C, BXSTS200PNRW and BXSTS200P as noted within the Thermal Solution Products Affected table below

Please determine your remaining demand for this product and place your last product discontinuance orders in accordance with the key milestones in this PCN.

Customers should place their Last Time Orders while supplies last with the latest to be by May 08, 2020 if supplies are still available, and delivery of all orders must be taken no later than November 06, 2020.

Customer Impact of Change and Recommended Action:

All the Intel processors that are compatible with these thermal solutions have already been discontinued so there will be no impact to the customers.

Please contact your local Intel Field Sales representative if you have any further questions about this End of Life notice.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Passive/Active Combination Heat-Sink with Removable Fan BXSTS200C, Single	BXSTS200C	915970
Passive Narrow Thermal Solution BXSTS200PNRW, Single	BXSTS200PNRW	915971
Passive Thermal Solution BXSTS200P, Single	BXSTS200P	915972

PCN Revision History:

Date of Revision:

June 1, 2020

Revision Number:

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Reason:

Originally Published PCN



Product Change Notification

117475 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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